High Intensity SMD LED

Color	Туре	Technology	Angle of Half Intensity $\pm \phi$
Soft orange	TLMF3100	AlInGaP on GaAs	60°

Description

This device has been designed to meet the increasing demand for AlInGaP technology.

The package of the TLME3100 is the PL–CC–2 (equivalent to a size B tantalum capacitor).

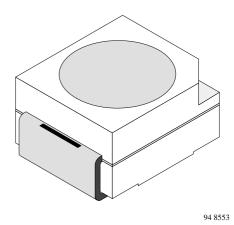
It consists of a lead frame which is surrounded with a white thermoplast. The reflector inside this package is filled up with clear epoxy.



- SMD LED with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leq 2.0$

Applications

Automotive: backlighting in dashboards and switches Telecommunication: indicator and backlighting in telephone and fax Indicator and backlight for audio and video equipment Indicator and backlight in office equipment Flat backlight for LCDs, switches and symbols General use



Absolute Maximum Ratings

 $T_{amb} = 25^{\circ}C$, unless otherwise specified

TLMF3100

Parameter	Test Conditions	Symbol	Value	Unit
Reverse voltage		VR	5	V
DC forward current	$T_{amb} \le 60 \degree C$	IF	30	mA
Surge forward current	$t_p \le 10 \ \mu s$	I _{FSM}	0.1	А
Power dissipation	$T_{amb} \leq 60^{\circ}C$	P _V	80	mW
Junction temperature		T _i	100	°C
Operating temperature range		T _{amb}	-40 to +100	°C
Storage temperature range		T _{stg}	-55 to +100	°C
Soldering temperature	$t \le 5 s$	T _{sd}	260	°C
Thermal resistance junction/ambient	mounted on PC board (pad size > 16 mm ²)	R _{thJA}	400	K/W

Optical and Electrical Characteristics

 $T_{amb} = 25^{\circ}C$, unless otherwise specified

Soft orange (TLMF3100)

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Luminous intensity	$I_F = 10 \text{ mA}$		I _V	25	50		mcd
Dominant wavelength	$I_F = 10 \text{ mA}$		λ_d	598	605	611	nm
Peak wavelength	$I_F = 10 \text{ mA}$		λ _p		610		nm
Angle of half intensity	$I_F = 10 \text{ mA}$		φ		±60		deg
Forward voltage	$I_F = 20 \text{ mA}$		V _F		2	2.6	V
Reverse voltage	$I_R = 10 \ \mu A$		V _R	5			V
Junction capacitance	$V_R = 0, f = 1 MHz$		Cj		15		pF

Typical Characteristics ($T_{amb} = 25^{\circ}C$, unless otherwise specified)

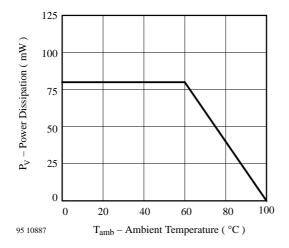


Figure 1. Power Dissipation vs. Ambient Temperature

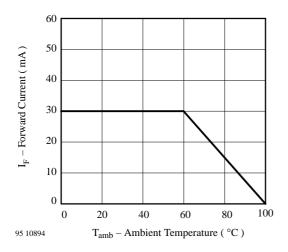


Figure 2. Forward Current vs. Ambient Temperature

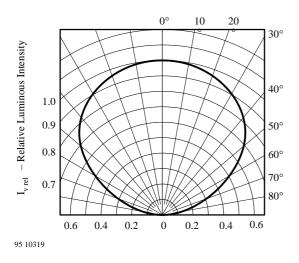


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

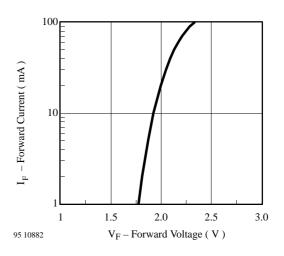


Figure 4. Forward Current vs. Forward Voltage

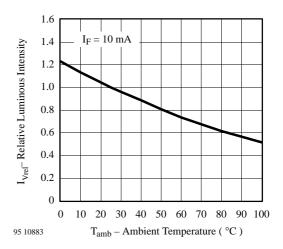


Figure 5. Rel. Luminous Intensity vs. Ambient Temperature

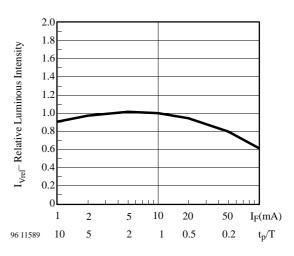


Figure 6. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

TELEFUNKEN Semiconductors

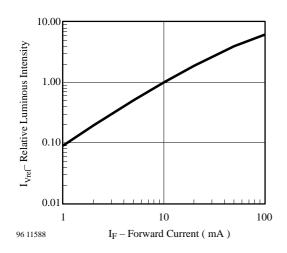


Figure 7. Relative Luminous Intensity vs. Forward Current

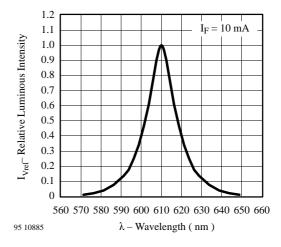
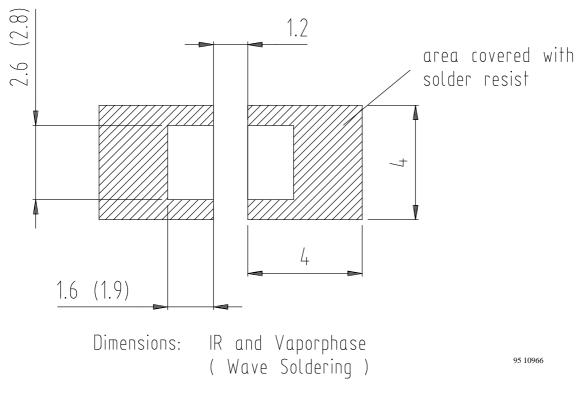
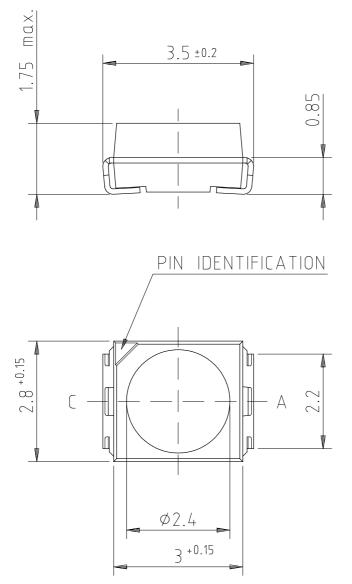


Figure 8. Relative Luminous Intensity vs. Wavelength



PCB Layout in mm

Dimensions in mm



95 11314

	1	(7	5
		C	P

technical drawings according to DIN specifications

Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

TEMIC TELEFUNKEN microelectronic GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423